

PATENT APPLICATION TRANSMITTAL LETTER

TO THE COMMISSIONER OF PATENTS AND TRADEMARKS:

Transmitted herewith for filing is the Patent Application of
LI-KUN CHOUfor
SEMICONDUCTOR PACKAGING STRUCTURE

Enclosed are:

- ☒ 3 sheets of drawings
- ☒ an assignment of the invention to
PAN PACIFIC SEMICONDUCTOR CO., LTD.
- ☐ a certified copy of a _____ application
- ☐ associate power of attorney
- ☒ a verified statement to ascertain small entity status under 37 CFR § 1.9 & 1.27

CLAIMS AS FILED

	NUMBER FILED	NUMBER EXTRA	RATE	FEE
BASIC FEE			\$760	\$760
TOTAL CLAIMS	6 -20	0	x 18	0
INDEPENDENT CLAIMS	1 -3	0	x 78	0
MULTIPLE DEPENDENT CLAIM PRESENT			\$260	0
NUMBER EXTRA MUST BE ZERO OR LARGER			TOTAL	\$760
If applicant is a small entity under 37 CFR 1.22, then reduce fee by 50%			SMALL ENTITY TOTAL	\$380
ASSIGNMENT			\$ 40	40
TOTAL PATENT APPLICATION FEE				\$ 420

- ☒ A check in the amount of \$ 420.00 to cover the filing fee is enclosed.
- ☒ The Commissioner is hereby authorized to charge and credit Deposit Account No. 18-2011 as described below. I have enclosed a duplicate copy of this sheet.
- ☐ Charge the amount of \$ _____ as filing fee.
- ☒ Credit any overpayment.
- ☒ Charge any additional filing fees required under 37 CFR 1.17
- ☒ for this filing, and/or
- ☒ for later presentation of extra claims.
- ☐ Charge any Patent Application processing fees under 37 CFR 1.17
- ☐ for this filing only, or
- ☐ during pendency of this Application
- ☐ Charge the issue fee set in 37 CFR 1.18 at or before mailing of the Notice of Allowance, pursuant to 37 CFR 1.317(b).

10/4/99

Date

Signature

Walter S. Dwyer

10/05/99

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